



**Changshu Talent
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**SK52L
THRU
SK510L**

Features

- Lead Free Finish/Rohs Compliant (Note1) ("P" Suffix designates Compliant. See ordering information)
- High Current Capability
- For Surface Mount Applications
- Higher Temp Soldering : 260°C for 10 Seconds At Terminals
- Available on Tape and Reel
- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1

Maximum Ratings

- Operating Temperature: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Maximum Thermal Resistance; 16°C/W Junction To Lead
55°C/W Junction To Ambient

| Catalog Number | Device Marking | Maximum Recurrent Peak Reverse Voltage | Maximum RMS Voltage | Maximum DC Blocking Voltage |
|----------------|----------------|--|---------------------|-----------------------------|
| SK52L | SK52 | 20V | 14V | 20V |
| SK53L | SK53 | 30V | 21V | 30V |
| SK54L | SK54 | 40V | 28V | 40V |
| SK55L | SK55 | 50V | 35V | 50V |
| SK56L | SK56 | 60V | 42V | 60V |
| SK58L | SK58 | 80V | 56V | 80V |
| SK510L | SK510 | 100V | 70V | 100V |

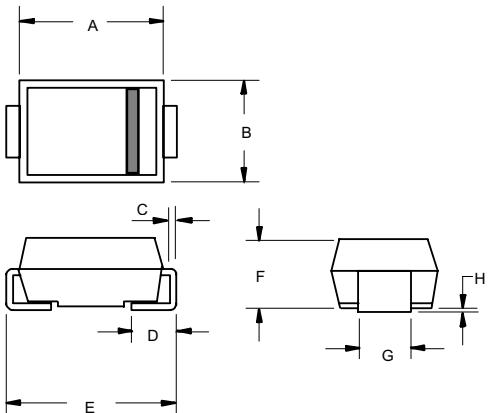
Electrical Characteristics @ 25°C Unless Otherwise Specified

| | | | |
|---|-------------|----------------------|---|
| Average Forward Current | $I_{F(AV)}$ | 5.0A | $T_A = 120^\circ C$ |
| Peak Forward Surge Current | I_{FSM} | 100A | 8.3ms, half sine |
| Maximum Instantaneous Forward Voltage SK52L~54L SK55L~56L SK58L~510L | V_F | .55V .75V .85V | $I_{FM} = 5.0A$; $T_J = 25^\circ C$ |
| Maximum DC Reverse Current At Rated DC Blocking Voltage | I_R | 1.0mA 20mA | $T_J = 25^\circ C$ $T_J = 100^\circ C$ |
| Typical Junction Capacitance | C_J | 200pF | Measured at 1.0MHz, $V_R=4.0V$ |

*Pulse test: Pulse width 200 μ sec, Duty cycle 2%
Note: 1. High Temperature Solder Exemptions Applied, see EU Directive Annex 7.

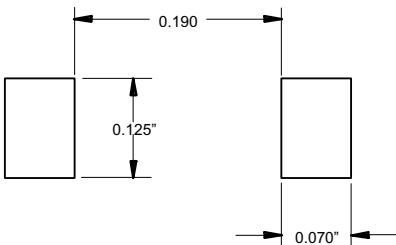
**5 Amp Schottky Rectifier
20 to 100 Volts**

**DO-214AB
(SMC) (LEAD FRAME)**



| DIM | INCHES | | MM | | NOTE |
|-----|--------|------|-------|-------|------|
| | MIN | MAX | MIN | MAX | |
| A | .260 | .280 | 6.60 | 7.11 | |
| B | .220 | .245 | 5.59 | 6.22 | |
| C | .006 | .012 | 0.15 | 0.31 | |
| D | .030 | .060 | 0.76 | 1.52 | |
| E | .305 | .320 | 7.75 | 8.13 | |
| F | .079 | .103 | 2.00 | 2.62 | |
| G | .108 | .128 | 2.75 | 3.25 | |
| H | .002 | .008 | 0.050 | 0.203 | |

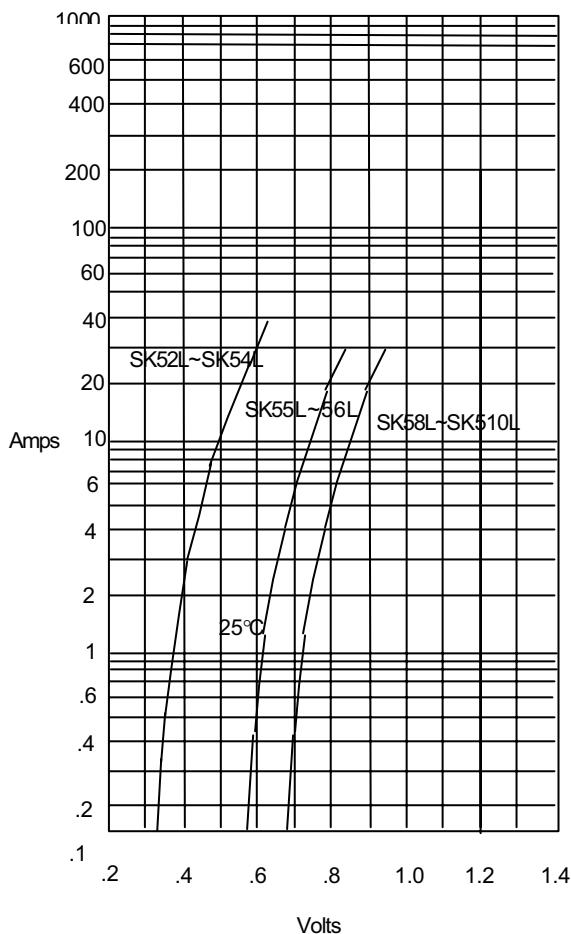
SUGGESTED SOLDER PAD LAYOUT



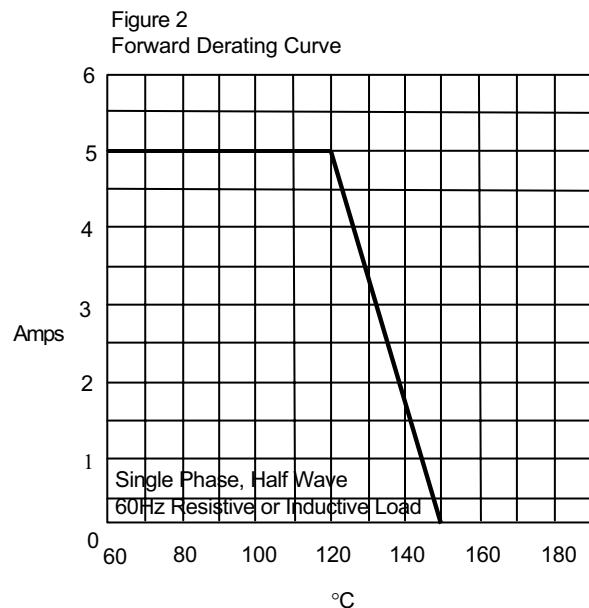


SK52L thru SK510L

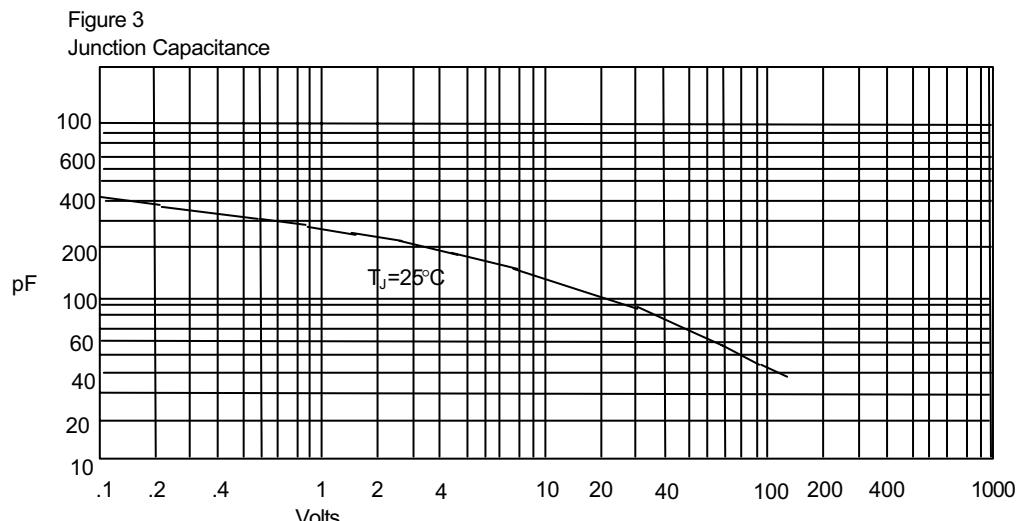
Figure 1
Typical Forward Characteristics



Instantaneous Forward Current - Amperes versus
Instantaneous Forward Voltage - Volts



Average Forward Rectified Current - Amperes versus
Ambient Temperature - °C

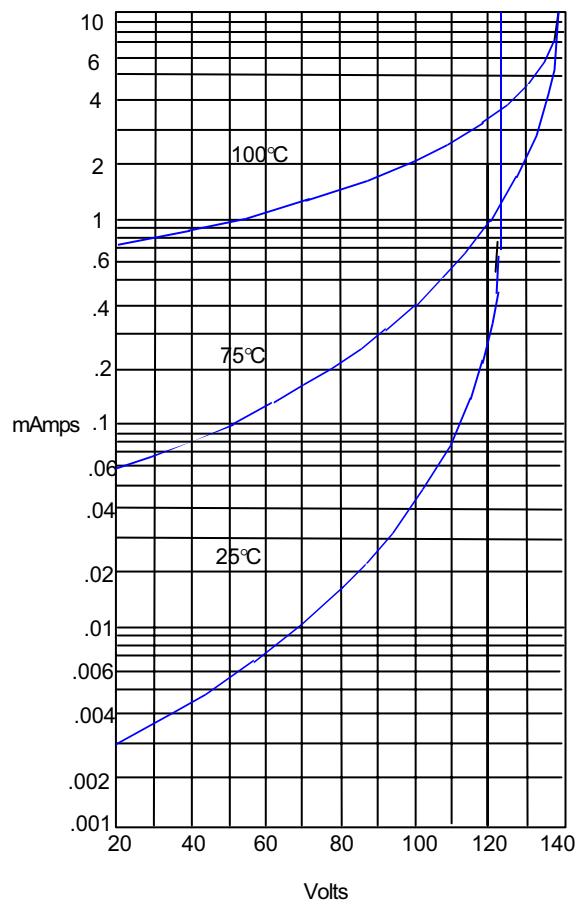


Junction Capacitance - pF versus
Reverse Voltage - Volts



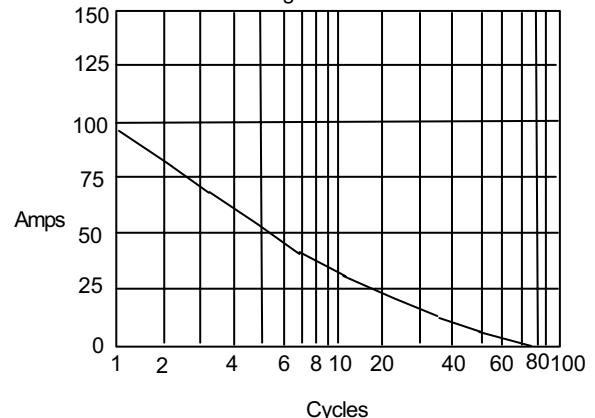
SK52L thru SK510L

Figure 4
Typical Reverse Characteristics



Instantaneous Reverse Leakage Current - MicroAmperes versus
Percent Of Rated Peak Reverse Voltage - Volts

Figure 5
Peak Forward Surge Current



Peak Forward Surge Current - Amperes versus
Number Of Cycles At 60Hz - Cycles